



Before using the Dexela flat panel X-ray detector please be sure to read these instructions thoroughly, along with any other documentation provided for software and/or other system components.

Keep these instructions easily accessible for future reference.

Table of Contents

1	Indications for use	6
1.1	Disclaimer.....	6
1.2	Contraindications:.....	6
1.3	Limitations on use	7
1.3.1	Interference with other devices	7
2	Storage and use	8
2.1	List of symbols and abbreviations	9
2.1.1	Symbols	9
2.1.2	Abbreviations.....	10
2.1.3	Other sources of information	10
3	Note on model variants	10
4	Description	11
4.1	Functions	12
4.2	Embedded features	12
4.3	Detector design	12
4.4	Power supply	13
4.5	Data interface.....	13
4.6	Servicing	14
5	Installation.....	15
5.1	Power Up Sequence.....	16
6	Producing a correct X-ray image.....	19
6.1	Power-down sequence	20
7	Calibration and image quality guidelines	20
8	External DC power supply requirements	22
8.1	Camera Link voltage requirements	22
8.2	GigE voltage requirements.....	23
9	Permanent mounting in an X-ray installation.....	24

10	Connection to a X-ray generator.....	25
11	Mode of operation	27
11.1	Trigger Modes	27
11.1.1	Software Trigger Mode.....	27
11.1.2	External Edge Trigger Mode.....	29
11.1.3	External duration trigger mode.....	31
11.1.4	Signal levels.....	33
11.2	Exposure modes	34
11.2.1	Expose and read	34
11.2.2	Sequence exposure.....	34
11.2.3	Frame-rate exposure.....	34
11.2.4	Pre-programmed exposure.....	35
11.2.5	Pre-shot mode.....	35
12	Installation in a medical system: data connection to the PC	36
13	Disposal – Waste Electrical and Electronic Equipment (WEEE) ..	38
14	Appendix 1 – Technical drawings	39
2923MAM CL.....	39	
2315MAM CL.....	40	
2923MAM GigE.....	41	
15	Appendix 2 - Installing and configuring Epix Camera Link cards.	42
15.1	Overview	42
15.2	Installing the card.....	42
15.3	Installing the Software and Driver	42
15.4	If the driver is not detected by Windows	45
15.5	Configuring memory for the frame buffer	46
15.6	Creating FMT files for use of third party applications.....	47
15.7	Troubleshooting	50
15.8	Installing and configuring of GigE devices	52

List of Figures

Figure 1: The detector used in a typical X-ray imaging system	11
Figure 2: Panel connections.....	16
Figure 3: Test patterns for 2923MAM and 2315MAM detectors.	17
Figure 4: Dark image.....	18
Figure 5: Raw X-ray image.....	18
Figure 6: Sample images.....	20
Figure 7: Power connector pin-out, panel view.....	23
Figure 8: On the left, correct air flow with baffles Preventing recirculation. On the right, wrong air flow where air flows back to inlet fan.....	25
Figure 9: Software trigger schematic. Values are shown in Table 7.....	27
Figure 10: Sync connection for software trigger mode.	29
Figure 11: Software trigger mode timing.	30
Figure 12: Sync connection for edge trigger mode.....	30
Figure 13: Edge trigger mode timing.....	31
Figure 14: Duration trigger mode timing.....	31
Figure 15: Sync connection for duration trigger mode.	32
Figure 16: Duration trigger mode timing.....	33
Figure 17: Expose and read mode.	34
Figure 18: Sequence exposure mode.....	34
Figure 19: Frame rate mode timing.....	35
Figure 20: Pre-programmed exposure mode, 2 images example.	35
Figure 21: Detector earthed to medical equipment. The same applied to GigE.	37
Figure 22: Protective earth between detector and PC. The same applied to GigE....	37
Figure 23: Camera Link isolation.....	37
Figure 24: Mains and LAN isolation. The same applied to GigE.....	37

List of Tables

Table 1: Storage and use conditions.	8
Table 2: List of symbols.....	9
Table 3: List of abbreviations.	10
Table 4: PC requirement.....	15
Table 5: DC supply requirements for CL MAM detectors.	23
Table 6: Power supply requirement for GigE MAM detectors.....	23
Table 7: Trigger timing specification.....	28
Table 8: Minimum rame readout times and fps.	28
Table 9: Duration trigger mode specification.	32
Table 10: Signal levels.....	33

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Company data:

Dexela Limited, a PerkinElmer company

Wenlock Business Centre

50 – 52 Wharf Rd

London N1 7EU

+44 20 7148 3107

www.dexela.com

1 Indications for use

1.1 Disclaimer

Unless otherwise specified, Dexela flat panel X-ray detectors are components intended to be integrated into products by X-ray system manufacturers.

System manufacturers are responsible for qualifying and validating their products for their intended uses, and for meeting all applicable regulatory requirements.



***WARNING: THE DETECTOR AND ASSOCIATED
COMPONENTS SHOULD ONLY BE INSTALLED AND USED BY
PERSONS WITH APPROPRIATE TRAINING AND
EXPERIENCE AND IN ACCORDANCE WITH THE
INSTRUCTIONS GIVEN IN THIS MANUAL.

DEXELA LIMITED MUST BE CONSULTED FOR GUIDANCE
WHEN INSTALLING DETECTORS IN A MEDICAL
APPLICATION.***

1.2 Contraindications:

THE DETECTOR AND ASSOCIATED PARTS SHOULD NOT BE USED FOR:

- obtaining images which are used as direct input to radiation treatment planning systems.
- imaging as part of a feedback system for servo-based surgical interventions
- imaging as part of a feedback system for image-guided radiotherapy
- direct control of x-ray beam duration or intensity, without other appropriate controls and interlocks.
- the detector is not intended for use as a dosimeter for measuring or controlling patient dose.



***WARNING: INTERPRETATION OF DIAGNOSTIC IMAGES IS A
SKILLED PROCEDURE AND SHOULD TAKE INTO ACCOUNT
THE PERFORMANCE LIMITATIONS AND IMAGE ARTIFACTS
ASSOCIATED WITH DIGITAL X-RAY DETECTOR PANELS.***

1.3 Limitations on use

Limitations on installation and usage are specified below, which are in accordance with the identified hazards and typical device classification:

- When installed in a host system, the detector **must be** installed within a housing or cover which prevents direct contact with a patient or operator
- The detector **must not** be used as part of a control or feedback system where the X-ray image can directly control surgical processes, therapeutic radiation or other processes which could potentially harm a patient as a consequence of a fault in the detector.
- The detector is able to signal to another part of the system (*e.g.* X-ray generator or computer) that an image is ready to be exposed via a BNC port on the back panel of the detector. The signal from the port **must not** be the sole activation means for X-ray delivery, and **must be** used in association with other control inputs: for example, a hand switch, safety interlocks, and a means of controlling the beam duration.
- The detector must not be used in a situation where it controls an X-ray dose delivered to a patient.

1.3.1 Interference with other devices



WARNING:

*ANY TESTING OF DEXELA FLAT PANEL X-RAY
DETECTORS DEMONSTRATES COMPLIANCE OF THE
DETECTORS IN ISOLATION.*

*WHERE SYSTEM COMPLIANCE (IE: TO IEC 60601-1-2:2007) IS
REQUIRED, TESTING WITH THE DETECTOR INTEGRATED
IN THE SYSTEM MUST BE COMPLETED AND IS THE
RESPONSIBILITY OF THE SYSTEM MANUFACTURER*

2 Storage and use

Dexela flat panel X-ray detectors may be used or stored within the following conditions:

Operation and storage (without packaging)	
Operating temperature	+10C to +40C
Storage temperature	-10C to +50C
Humidity	10% to 90% non condensing
Atmospheric pressure	690 hPa – 1080 hPa
Transportation (packaged)	
Temperature range	-10C to +50C
Humidity	0 to 98% non condensing
Atmospheric pressure	690 hPa – 1080 hPa

Table 1: Storage and use conditions.



***WARNING: WHEN DEXELA FLAT PANEL X-RAY
DETECTORS ARE TRANSFERRED FROM EXTREME
TEMPERATURE OR HUMIDITY CONDITIONS, ALLOW AT
LEAST ONE HOUR OF STABILISATION TO NORMAL
OPERATING TEMPERATURE OR HUMIDITY PRIOR TO USE.***

2.1 List of symbols and abbreviations

2.1.1 Symbols

Symbol	Description
	Equipment should not be disposed of in the normal waste stream
	Manufacturer
	Catalogue number
	Serial Number
	Class II double insulation
	Ground

Table 2: List of symbols.

2.1.2 Abbreviations

MAM	Mammography
GigE	GigE vision interface
CL	Camera Link
PSU	Power supply unit
Fps	Frames per second
ADC	Analog-to-digital
DAQ	Data acquisition
T_R	Readout time
T_{EXP}	Exposure time

Table 3: List of abbreviations.

2.1.3 Other sources of information

Software instructions

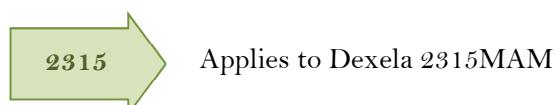
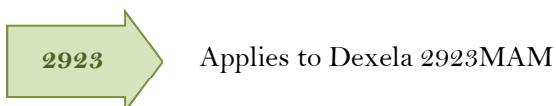
The SCAP application is fully described in
SCAP User Instructions

Software developers' resources

The **Native API** (Application Programming Interface) provides hardware interfacing functions as well as image processing utilities for developers integrating the detectors into custom applications.

3 Note on model variants

These instructions for use describe the complete range of Dexela flat-panel X-ray detectors. Where the information is specific to one model, the following symbols are used:



When GigE or CL connectors have to be specified, the 'CL' or 'GigE' indication will be added to the above symbols.

4 Description

An X-ray detector panel converts an incident X-ray signal into a digitised image. It is used in association with other components, including: an X-ray tube and generator, a support structure and housing, a DC power supply and a host computer, which together form a complete medical imaging system.

Dexela flat panel X-ray detectors are supplied to X-ray equipment manufacturing companies as a component of a larger system (see Figure 1) They may be supplied with optional power supply units and cables on request.

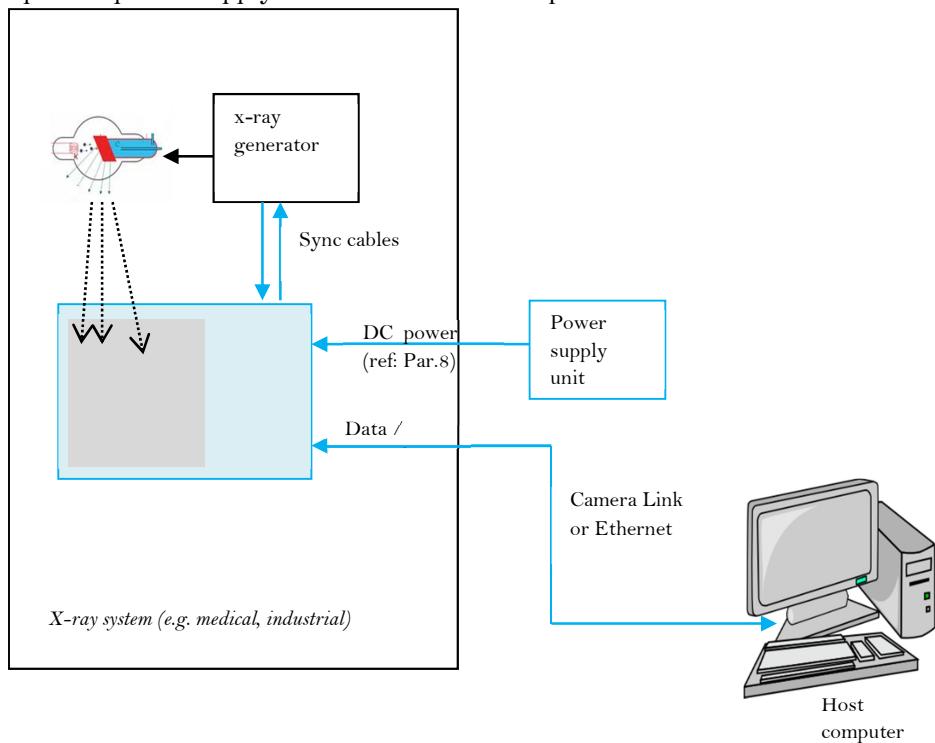


Figure 1: The detector used in a typical X-ray imaging system

The detector does not function as a stand-alone system and requires an X-ray generator to produce images. BNC ports on the detector allow direct connection to an X-ray generator for synchronising the X-ray exposure with the image read-out.

The detector is designed to be used with a PC which can process, display and store images.

Dexela is able to supply a range of development software, including drivers and source code, which will enable developers to interface the detector with a range of third-party or proprietary imaging software.

SCAP, a Windows application (also supplied by Dexela), allows the user to acquire, process, store and display images. It may be used as a stand-alone application for test or research purposes only, or as a utility for the testing and evaluation of the detector before designing into an end system.

www.perkinelmer.com



WARNING: SOFTWARE PROVIDED BY DEXELA IS INTENDED TO BE USED FOR INTEGRATION, TEST OR RESEARCH PURPOSES ONLY. IT **MUST NOT** BE USED IN A MEDICAL APPLICATION.

4.1 Functions

The detector performs the following functions within a typical X-ray system:

- conversion of incident X-rays into a digitised image
- transmission of a raw image to a remote host computer as a serial data stream
- control of basic image adjustments: offset and linearity

4.2 Embedded features

Dexela flat panel X-ray detectors are designed with several functions built in to provide the user with flexibility when undertaking X-ray imaging tasks. The detector is designed so that the balance between image resolution, sensitivity and readout speed can be adjusted continuously by the PC software.

The detectors have two pixel sensitivity settings, optimized for high sensitivity (real time imaging) and high dynamic range (static imaging). The 2923MAM and 2315MAM models covered by these instructions for use do not have binning modes.

4.3 Detector design

The Dexela mammography series of detectors are based on the same CMOS sensor design and use 75 μ m square pixel pitch with two different sizes and different tiling configurations:

<u>Model</u>	<u>Sensor unit</u>	<u>Tiling</u>
2315MAM	3072 columns x 1944 rows	2 x 1
2923MAM	3888 columns x 3072 rows	2 x 2

The sensors are tiled, the gap between active pixels across the butting gap is one pixel wide (75 μ m), using software to improve image presentation, the corresponding missing row or column may be recreated

The CMOS sensor is optically coupled to a scintillator plate, which converts X-ray photons to light photons. The coupling is via a Fibre Optic Faceplate (FOP) which is used to shield a significant amount of X-rays from the sensor, that could otherwise generate image noise and cause gradual damage

The scintillator plate, composed of Caesium Iodide, is pressed in contact with the FOP but not glued. The unit is housed in an aluminium enclosure, with a carbon fibre composite panel providing an X-ray ‘window’.

A circuit board (ADC) connected to each CMOS sensor digitises the analogue signals, and provides the timing signals needed to drive them. A communications board (DAQ) converts the data stream from the ADC(s) to the required format, either Camera Link or Gigabit Ethernet.

Cooling is provided by two fans - one drawing in cold air and the other extracting. The enclosure is also cooled passively by conduction and convection, to ensure that a failure of either fan would not cause the detector to overheat. Fan cooling is implemented to improve performance, which is best at lower temperatures.

4.4 Power supply

All Dexela flat panel X-ray detectors require a DC power supply, details of the power requirements can be found in section 8.

When a detector is to be used in a medical application, it is recommended that an IEC 60601-1 compliant PSU is used.

Integration of the power supply into a final system is the responsibility of the system manufacturer along with any associated qualification and validation.



WARNING: POWER SUPPLY MUST IN ALL CASES PROVIDE CLASS II DOUBLE ISOLATION.
FOR MEDICAL APPLICATIONS IT IS RECOMMENDED THAT AN IEC 60601-1 COMPLIANT PSU IS USED. SEE SECTION 8 FOR INDIVIDUAL DETECTOR POWER REQUIREMENTS.

4.5 Data interface

Communication between the Dexela flat panel X-ray detectors and the host computer is via Camera Link or Gigabit Ethernet (according to the product variant).

In the case of **Camera Link**; Dexela software drivers are written for the EPIX range of frame grabbers, but other software may be used if the appropriate Dexela drivers are integrated.

In the case of **Ethernet**; the interface is using GigE Vision standard, and requires a 1000BaseT network interface card (NIC).



WARNING: IT EQUIPMENT ATTACHED TO DEXELA FLAT PANEL X-RAY DETECTORS WITHIN THE MANUFACTURERS SYSTEM SHOULD BE IEC60950 APPROVED AS A MINIMUM.

4.6 Servicing

The service and repair of the detector unit should only be carried out by a qualified Dexela service agent. Under no circumstances should you attempt to disassemble the detector(s). **There are no user-serviceable parts inside.**

Opening or removing parts from the detector(s) may result in exposure to dangerous voltages or other risks. Incorrect reassembly of the detector(s) may result in electric shock to the user when subsequently operated.

In case of fault please immediately contact Dexela using details below to arrange for the detectors return

Dexela Limited, a PerkinElmer company

Wenlock Business Centre
50 – 52 Wharf Rd
London N1 7EU

+44 20 7148 3107

www.dexela.com



WARNING: ABSOLUTLEY NO MODIFICATION OF DEXELA X-RAY PANEL DETECTORS IS PERMITTED

5 Installation



WARNING: DEXELA FLAT PANEL X-RAY DETECTORS ARE DESIGNED TO BE USED AS COMPONENTS OF A MEDICAL SYSTEM AND ARE SUPPLIED FOR INTEGRATION ONLY

This installation procedure applies to the development kit supplied by Dexela, which includes the following items:

- Detector unit
- Software installation disk (CD-ROM)
- User documentation

OPTIONAL – PROVIDED ON REQUEST

- Mains power supply unit (PSU)
- DC cable
- Camera Link cables
- Mains cable
- EPIX frame grabber board

In addition, a PC is required to control the detector and receive images. The minimum requirements for the PC are shown in Table 4 below.

Processor:	Intel i5
Memory:	2GB
Disk space:	10GB
Spare slot:	PCIe x4
NIC	Intel PRO 1000/PT board
Operating system:	Win7 (32 Bit / 64 Bit), Win XP Pro (32 Bit / 64 Bit)

Table 4: PC requirement.

Using the steps described in the following pages, a Dexela flat panel X-ray detector model 2923MAM CL may be installed and connected, and a first raw X-ray image captured.



WARNING: THE DETECTOR AND ASSOCIATED COMPONENTS SHOULD ONLY BE INSTALLED AND USED BY PERSONS WITH APPROPRIATE TRAINING AND EXPERIENCE AND IN ACCORDANCE WITH THE INSTRUCTIONS GIVEN IN THIS MANUAL.

DEXELA LIMITED MUST BE CONSULTED FOR GUIDANCE WHEN INSTALLING DETECTORS IN A MEDICAL APPLICATION.



**WARNING: DEXELA FLAT PANEL X-RAY DETECTOR'S
CONTAINS FRAGILE OPTICAL AND ELECTRONIC PARTS.
EXCESSIVE SHOCK AND VIBRATION DURING HANDLING
AND INSTALLATION MAY CAUSE DAMAGE**

Error! Not a valid bookmark self-reference. below shows the connections found on Dexela flat panel X-ray detector units.

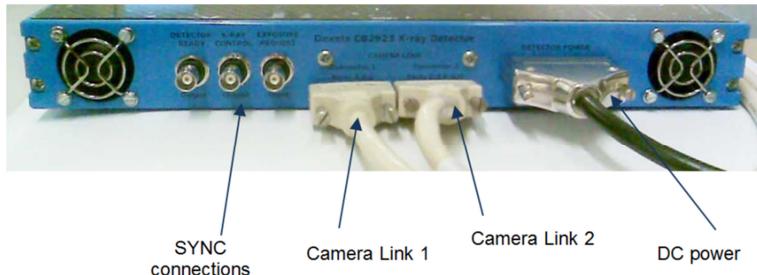


Figure 2: Panel connections.

2923

The 2923MAM CL has two Camera Link Full 80MHz, the 2923MAM GigE has one GigE connection. Both have three SYNC connections on the back panel (one SYNC IN and two SYNC OUT).

2315

The 2315MAM CL has two Camera Link Medium 80MHz and the 2315MAM GigE has one GigE connector. Both have three SYNC connections on the back panel (one SYNC IN and two SYNC OUT).

The instructions below at all times assume that the PSU and accessories supplied are those available as an option from Dexela.

If you are using alternative accessories/PSU please follow the manufacturers instructions for your specific make and model at each stage below.

1. (This point 1 is for CL detectors only) Install the EPIX E4 frame grabber board in a spare PCI Express slot in the host PC. Insert the EPIX CD-ROM and follow the on-screen instructions to install the device drivers.

5.1 Power Up Sequence

2. Install the detector unit and PSU in a suitable place (below) in the X-ray device. Install in positions where there is adequate air circulation, the fan aperture is not covered and warm air is expelled to the room and does not circulate back into the unit. The detector unit will become warm during continuous operation - this is normal.

3. Connect the DC power cable between the PSU and the detector. Connect the PSU mains cord to a suitable outlet (110 – 250V AC, 50 – 60Hz), but do not switch it on yet.



WARNING, IF USING DEXELA SUPPLIED PSU:DO NOT REMOVE THE COVER OF THE PSU, THE PSU CONTAINS PARTS WITH EXPOSED HIGH VOLTAGE TERMINALS. DO NOT COVER THE PSU, OR OBSTRUCT THE AIR VENTS ON THE BACK OR THE UNDERSIDE OF THE UNIT, THIS MAY LEAD TO OVERHEATING. THE PSU MUST NOT BE MODIFIED.

THIS WARNING IS RELEVANT TO MOST PSU, HOWEVER PLEASE REFER TO MANUFACTURERS INSTRUCTIONS FOR YOUR SPECIFIC MAKE AND MODEL

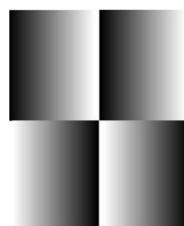
4. Complete the Dexela software installation (see **SCAP User Instructions**).
5. **Camera Link:** Connect the Camera Link cables between the detector and the EPIX board in the PC. For both 2923 and 2315, Connector 1 on the detector should be wired to the connector nearest the PC motherboard. **GigE:** Connect the GigE cable between the detector and the Intel PRO 1000/PT board in the PC.
6. Switch on the PC. Then switch on the PSU, and check that it is operational as per manufacturers instructions.).

SCAP should be launched after the detector has been powered-up. This ensures that configuration and calibration data is downloaded to the detector's internal memory when SCAP starts. (For the next stages, refer also to SCAP User Instructions.)

7. Start Windows and then launch SCAP.
8. Click on **Test Mode** then click **Snap**. A quad grey-scale pattern should appear, as in Figure 3. This indicates that the detector unit is communicating correctly with the PC.



The 2923 displays a quad grey scale:



The 2315 displays a double grey scale:

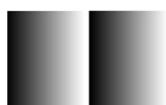


Figure 3: Test patterns for 2923MAM and 2315MAM detectors.

9. Ensure that the **Auto-contrast** check box is ticked. Click on **Normal** then click **Snap** again. A blank image similar to Figure 4 should be visible. This is a high-contrast image which shows different sections of the panel as grey vertical rectangles.

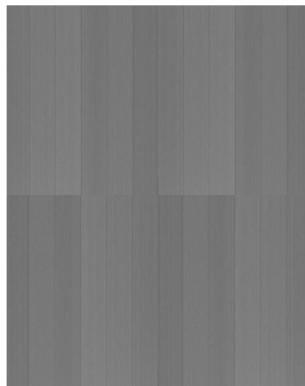


Figure 4: Dark image.

10. Position the detector unit under the X-ray source with a small metal object (*e.g.* pen) placed diagonally on the detector surface, within the white square, near the centre.

Set the generator to 30kV, 5mA with an SID of 60cm.

11. Set the detector exposure time to 100ms using the **Configuration** menu. With the X-ray beam on, capture a single image by clicking **Snap**.

An uncorrected image should be visible, similar to Figure 5. Some vertical lines may be visible on the image - this is normal.

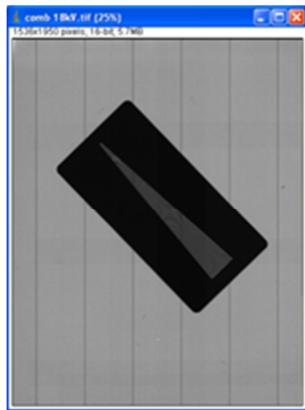


Figure 5: Raw X-ray image.

12. The image may appear too dark or too bright. Move the cursor over the displayed image, and note the pixel **Value** (displayed to the right of the image).

- If it is above 16,000, the image is overexposed, and the X-ray mA should be reduced.
 - If it is below 2,000, the image is underexposed, and the tube mA should be increased. If the mA cannot be increased the exposure time can be increased instead.
13. When the combination of mA and exposure time which gives an open-field pixel value of around 12,000 – 14,000 has been determined, **note this combination**. It will be used for the next stage.

6 Producing a correct X-ray image

In the following steps, the detector is calibrated so that fully corrected images can be displayed, this allows SCAP to provide automatic correction of X-ray images immediately after they are captured.

Two calibration images must be obtained first.

Dark current calibration image:

14. Under the **Configuration** menu, select **Darks**. Enter the **Exposure time** noted in step 13 above, and set **Quantity** to 10.
15. With the X-ray beam off, under the **Tools** menu, select **Collect Dark**. A set of 10 dark images will now be captured, averaged and stored for background subtraction.

Flood field calibration image:

16. Under the **Configuration** menu, select **Floods**. Enter the **Exposure time** noted in step 13 above, and set **Quantity** to 10.
17. Remove any object from the field of view.
18. Turn the X-ray beam on, with the same mA setting as in step 13 above.
19. Under the **Tools** menu, select **Collect Flood**.

An average of 10 images will now be calculated and stored as a flood image for flat-field gain correction.

Ensure that the X-rays do not terminate before the images have been captured.

Producing a corrected X-ray image

20. Tick all 7 check boxes to the right of the image display: **Auto-contrast**, **Auto-descramble**, **Linearisation**, **Dark correction**, **Gain correction**, **Defect correction** and **Suppress zingers**.
21. Place a phantom or test object on the detector surface or anywhere within the field of view.
22. Using the mA and exposure time as in step 13 above, start X-rays and click **Snap**.

The result should be a clean-looking image with no obvious background shading, striping, artefacts or lines, as shown below (Figure 6):

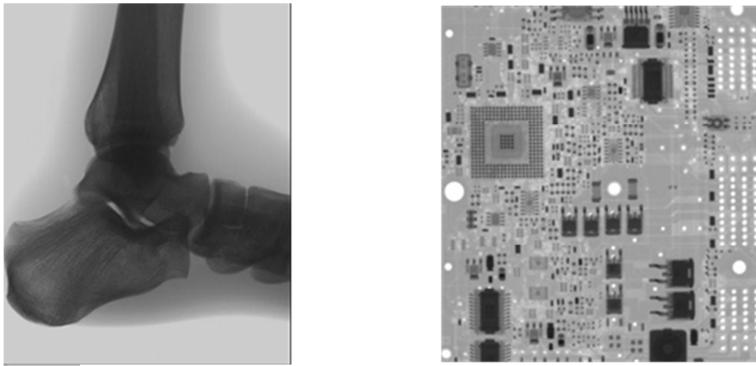


Figure 6: Sample images.

6.1 Power-down sequence

- Close Scap following the manufacturer instruction.
- If the PSU has an independent on/off switch ensure this is in the off position
- Unplug the PSU from the detector.
- Switch off the PSU at the wall

7 Calibration and image quality guidelines

SCAP provides image processing stages which compensate for imperfections of the X-ray system and detector:

- Beam flatness and heel effect
- Scintillator grain
- Visible structures in the protective cover and fibre optic plate
- Pixel voltage offset and gain variation
- Pixel non-linear response
- Defective lines and pixels

The automatic image processing functions provided in SCAP are:

Dark correction: The dark image is an average of several dark frames. Dark correction removes static offsets between pixels, so that a dark image is presented as an approximately uniform grey value. The dark correction is sensitive to changes in integration time and temperature. The averaged dark image should be acquired shortly before or after the acquisition of the image to be corrected and with the same integration time.

Linearity correction: Detector pixels have a slightly non-linear response to light, which corresponds to about 2% deviation from the linear response at mid-scale. To ensure that the flood calibration works accurately over the dynamic range of the detector, both the raw image and the flood image are corrected for non-linearity.

Gain correction: The flood calibration image can be inspected under the **View** menu, and is a floating-point multiplication matrix normalised to 1. The calibration image is

created from the average of several flood images, which are also dark corrected. Multiplying by the flood calibration image has the effect of reversing the variation in X-ray conversion gain between pixels or regions, so that a corrected open field X-ray image will have near-constant grey levels across the field of view.

Defect correction: Some defective lines and pixels may be present on the sensor. These are defined as having a response which deviates by a specified amount from the ideal. A defect map is created during factory testing of the detector and is installed in the SCAP program folder. On the final processed image, pixels tagged on this defect map are replaced by interpolated values in order to improve the image presentation.

Guidelines for achieving optimum image quality:

- When creating flood and dark calibration images, and when doing frame-averaging operations, set **Quantity** to as large a value as possible, within practical time constraints. When **Quantity** is large, the images will take longer to acquire, but the noise is reduced. As a general rule, the noise reduces by a factor of $\sqrt{2}$ (≈ 1.4) when **Quantity** is doubled.
- When changing the exposure time significantly, create a new dark calibration image with the same exposure time as the image that is to be acquired. A frequently renewing of the dark images is recommended to improve the image quality.
- Update the flood calibration image if changing the technique (kV-mA), source-imager distance (SID), or beam incident angle significantly. For clinical or industrial applications, several sets of dark and flood images may be stored and called up according to the X-ray generator settings.
- Aim for an open-field signal level of around 11,000 – 12,000 for flood calibration images, this will give good dynamic range without saturation.
- The Dexela flat panel X-ray detector is designed for maximum sensitivity to X-rays, enabling optimal image quality for a low dose exposure. In some situations, a higher dose is used to improve the image quality, but this may cause the pixels to saturate. The solution is to use a shorter detector exposure time, and to capture more than one frame by using the **Collect Average** function (in the **Tools** menu) instead of **Single Exp**. This will generate an average of several frames, rather than a single saturated frame. The averaging process reduces the image noise. The number of averaged frames can be set in the **Configuration** menu.
- Two settings of pixel gain can be programmed via the **Configuration** menu:
 - **High Full Well** mode should be used where high saturation dose is important, and this would apply to most static X-ray imaging applications including mammography.
 - **Low Full Well** mode increases the pixel gain by a factor of approximately 3.5 in comparison to High Full Well mode, and this mode

should be used where high sensitivity (low dose per frame) is required. This mode is suitable for fluoroscopy and tomosynthesis.

8 External DC power supply requirements



***WARNING: POWER SUPPLY MUST IN ALL CASES
PROVIDE CLASS II DOUBLE ISOLATION. FOR MEDICAL
APPLICATIONS IT IS RECOMMENDED THAT AN IEC
60601-1 COMPLIANT PSU IS USED.***

***THE DETECTOR MUST BE CONNECTED TO A POWER
SUPPLY UNIT WHICH HAS BEEN SUPPLIED BY DEXELA, OR
A POWER SUPPLY UNIT WHICH IS CONSTRUCTED IN
ACCORDANCE WITH THE REQUIREMENTS IN THIS
SECTION. FAILURE TO USE THE CORRECT POWER SUPPLY
MAY CAUSE THE DETECTOR TO OVERHEAT.***

A means of isolating the Power Supply must be provided (by the system manufacturer) which enables the disconnection of both Live and Neutral poles simultaneously.

As low DC voltages are used to supply the detector, the voltage drop in the DC cable is a significant factor.

POWER SUPPLY VOLTAGES MUST BE HIGH ENOUGH TO OVERCOME A VOLTAGE DROP CAUSED BY CONDUCTOR RESISTANCE IN THE CABLES - ESPECIALLY WHERE THINNER CONDUCTORS ARE USED IN FLEXIBLE CABLES FOR ROTATING OR MOVING PLATFORMS.

The power supply must be designed together with the cable, to ensure that the correct voltages are delivered at the connector taking into account voltage drops. During normal operation of the detector the current is constant and does not vary significantly.

The detector can be powered using a DC power supply and cables, in accordance with the requirements in the pages to follow. The supply voltage requirements for the detector are measured at the detector power input connector.

Note: When installed within a medical system, it is recommended that the external DC supply is compliant with safety and EMC standards appropriate to Medical Devices: IEC 60601-1 and IEC 60601-1-2.

Use mating connector type Conec 3005W5SXX99A10X or equivalent for CL detector and FGG.1B.303.CLAD52Z for GigE.

8.1 Camera Link voltage requirements

The supply voltage requirements for the detectors, as measured at the detector power input connector, are shown in Table 5 below:

Pin	Voltage (relative to pin 5)		2923 CL		2315 CL	
	Min	Max	Current (active)	Current (standby)	Current (active)	Current (standby)
1 , 2	+4.0V	5.5V	4.0A	0.7A	2.0A	0.3A
3	+6.0V	+7.5V	2.5A	0A	1.3A	0A
4	-6.0V	-7.5V	0.5A	0A	0.2A	0A
5	0V		5.3A return	0.7A return	3.0A return	0.3A return
<i>Ripple and noise, all outputs</i>		1% peak-peak measured over 0- 20MHz				

Table 5: DC supply requirements for CL MAM detectors.

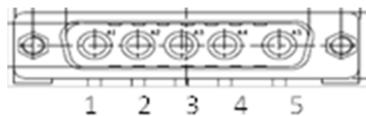


Figure 7: Power connector pin-out, panel view.

Note: Use mating connector type Conec 3005W5SXX99A10X or equivalent

8.2 GigE voltage requirements

The supply voltage requirements for the GigE detectors, as measured at the detector power input connector, are shown in Table 6 below.

Pin	Voltage (relative to pin 5)		2923	
	Min	Max	Current (active)	Current (standby)
1	+23V	+25V	1.61A	0.22A
2	Earth		0A	0A
3	0V		1.61A return	0.22A return
<i>Ripple and noise, all outputs</i>		1% peak-peak measured over		

Table 6: Power supply requirement for GigE MAM detectors.

Note: Use mating connector: FGG.1B.303.CLAD52Zor equivalent

9 Permanent mounting in an X-ray installation

Mounting

The detector unit should be mounted in a frame or chassis using the mounting points. The unit must be mounted under a cover which prevents direct contact with a patient or operator.



WARNING: THE TOP PLATE OF THE DETECTOR IS CONSTRUCTED FROM A FLAMMABLE MATERIAL. ENSURE THAT THE COVER IS MADE OF A MATERIAL WHICH HAS THE APPROPRIATE FLAMMABILITY RATINGS FOR MEDICAL EQUIPMENT.

Protective earthing

A protective earth terminal is located on the back panel, this is used for grounding the unit to minimise any mains leakage current which may be generated if the primary earth connection on the PSU or PC is disconnected.

It should be connected to the nearest available grounding point on the earthed equipment chassis or frame.

The earthing connection should be able to withstand a continuous current of 40A - this can be achieved by installing an earth cable of **at least** 18AWG conductor thickness which should be terminated with crimped ring terminals and secured with screws of 4mm diameter or larger.

Cooling

The detector units generate heat during continuous use. This heat must dissipate to the surrounding air, or the equipment in which the detector is installed.

The 2923MAM CL and 2315MAM CL have forced air cooling provided by fans, which run in the powered-on state. The air flowing through the detector is sufficient to cool the unit without relying on conductive or convective cooling provided that the air flows into the entrance fan from the outside of the X-ray housing, and is expelled such that it does not loop back into the fan inlet. Baffles or other blocking arrangements can be used to enforce this air flow.

Examples of correct and incorrect arrangements are as follows:

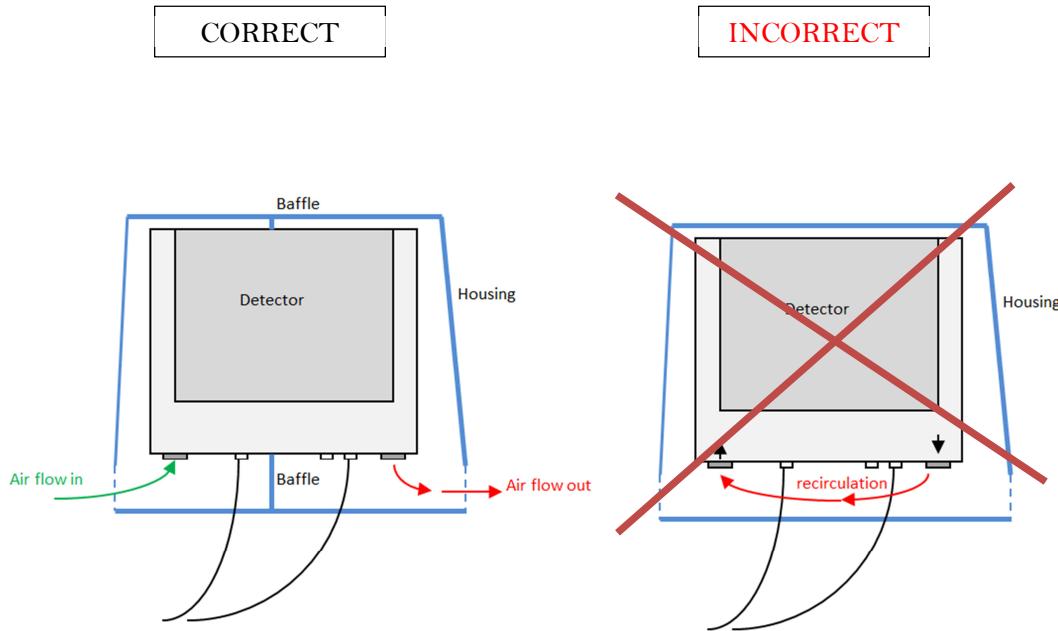


Figure 8: On the left, correct air flow with baffles Preventing recirculation. On the right, wrong air flow where air flows back to inlet fan.

Inlet and outlet vents in the housing must each have a cross sectional area of at least 15 cm².

10 Connection to a X-ray generator

Dexela flat panel X-ray detectors can be used in a stand-alone mode, where the detector image acquisition is triggered by software (via the data interface) while X-rays are controlled separately.

In an integrated X-ray machine, the image acquisition is controlled automatically by the X-ray generator in response to the operator starting the beam. This requires communication between the generator and the detector.

The detector is supplied with BNC connectors which provide a direct connection to an X-ray generator to allow for timing synchronisation.

The following synchronisation modes are supported:

1. Software Trigger Mode - the trigger is sent by the software (SCap or API function) using Camera Link
2. Edge Trigger Mode – the detector can trigger the X-ray generator when the sensor is ready to be exposed
3. Duration Trigger Mode - the detector image capture is timed by a hardware signal from the generator.



***WARNING: THE DETECTOR IS NOT DESIGNED TO
CONTROL THE DURATION OF AN X-RAY EXPOSURE.
OUTPUT SIGNALS FROM THE DETECTOR SHOULD BE USED
TO INDICATE THAT THE DETECTOR IS READY TO ACQUIRE
AN IMAGE, OR WHEN THE X-RAY EXPOSURE SHOULD
START, OR OTHER EVENTS WHICH DO NOT INFLUENCE OR
EXTEND THE X-RAY EXPOSURE TIME.***

11 Mode of operation

11.1 Trigger Modes

Triggering the detector is the attempt to synchronise the detector to other devices e.g. X-ray sources having their specific schemes of radiating X-ray pulses.

11.1.1 Software Trigger Mode

In Software Trigger Mode, the trigger is sent by the software (SCap or API function). In SCap, this mode is selected using **Configuration – External Trigger Mode – Software Trigger** and following the sequence below (see Figure 9: Software trigger schematic. Values are shown in Table 7.).

1. Before an exposure, the detector is continuously reading dark frames from the sensor to avoid the accumulation of dark current in the pixel.
2. The user sends the trigger signal from the software to the detector (T_{WSI}).
3. When the detector receives the trigger, it finishes the current readout (T_R).
4. After T_R the detector enters the exposure period (T_{EXP}) and the **Sync Out 2** level changes.
5. At the same time, the detector starts accumulating the image on the sensor.
6. After the detector's programmed exposure time T_{EXP} , the frame is read out and transmitted to the PC.
7. The detector resumes the dark frame readout cycles until the next software trigger.

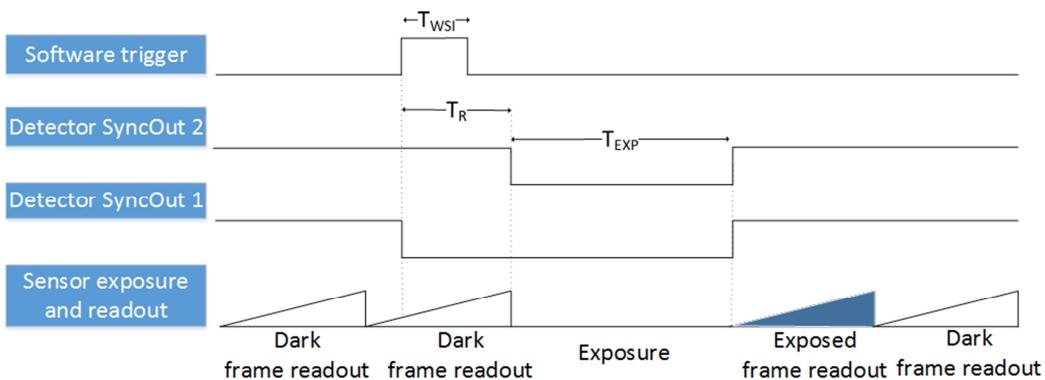


Figure 9: Software trigger schematic. Values are shown in Table 7.

Symbol	Description	Value	Notes
T _{WSI}	Sync In pulse duration	Minimum = 200 μ s	Shorter pulses (e.g. 1.5 μ s) will work in software trigger, but cannot be guaranteed for an external trigger.
T _R	Detector reset time	Minimum = 200 μ s Maximum = See Frame readout times Table 4 to check the maximum reset time for each detector.	T _R is measured from the rising edge of the trigger to the falling edge of Sync Out 2.
T _{EXP}	Sync Out 2 pulse width	Minimum: 200 μ s	T _{EXP} is the frame exposure time (not including the readout- see Table 8). Due to latency in the optocoupler, a pulse sent to the output has an additional 100 μ s duration.

Table 7: Trigger timing specification.

In some generators, there may be a delay between asserting **Sync Out 2** and the actual start of X-ray emissions. This must be compensated by increasing the programmed exposure time T_{EXP}, so that frame readout does not start before the X-ray emission has finished.

Sync Out 1 indicates when the detector is ready to accept a **Sync In** pulse. It is low (inactive) during a system reset cycle, during power-down (sleep) mode, and during a frame exposure cycle.

	Frame readout time [ms]	Frame per second
2923CL	57.0	17.6
2315CL	57.0	17.6
2923 GigE	188.7	3.6

Table 8: Minimum rame readout times and fps.

Note: the GigE frame per second is slower than the one expected from the readout time (1000ms/readout time), this is due to a longer time needed for the data to be delivered.

Example – Common case:

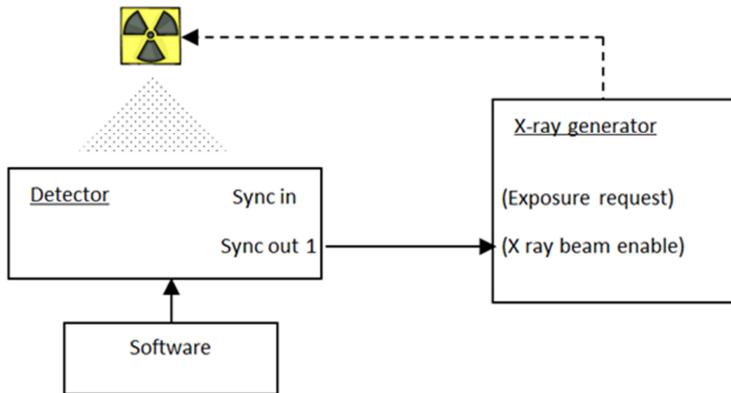


Figure 10: Sync connection for software trigger mode.

In this case, the generator is informed that the detector is ready to receive the X-ray emission when the Sync Out 2 level changes (step 4 of the Sequence explanation).

11.1.2 External Edge Trigger Mode

In External Edge Trigger Mode, the detector is triggered by an external signal, i.e. Generator. The detector exposure time is pre-defined by the software (SCap or API). In SCap, this mode is selected using **Configuration – External Trigger Mode – External Edge Trigger** and the following steps below:

1. Before an exposure, the detector is continuously reading dark frames from the sensor.
2. The user activates an external signal that drives **Sync In** high and the **Sync Out 1** level changes.
3. When the detector receives the trigger, it finishes the current readout (T_R).
4. After T_R the detector enters the exposure period (T_{EXP}) and the **Sync Out 2** level changes.
5. At the same time, the detector starts accumulating the image on the sensor.
6. After the detector's programmed exposure time T_{EXP} , the frame is read out and transmitted to the PC.
7. The detector resumes the dark frame readout cycles until the next **Sync In** pulse.

It behaves essentially like the Software Trigger Mode but the trigger signal comes from an external source and it's directed into the SyncIn port. The timing specifications are shown in Table 7.

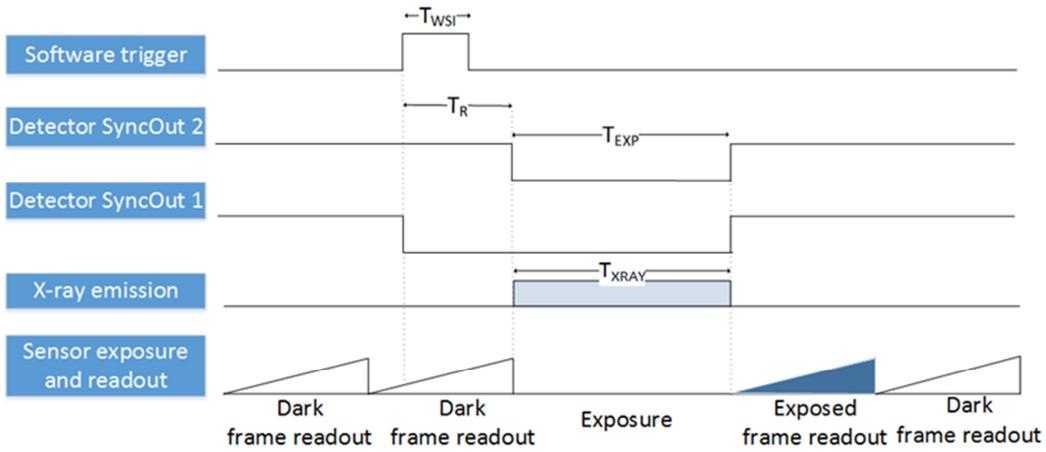


Figure 11: Software trigger mode timing.

Sync Out 1 indicates when the detector is ready to accept a **Sync In** pulse. It is low (inactive) during a system reset cycle, during power-down (sleep) mode, and during a frame exposure cycle.

Example – Common Case:

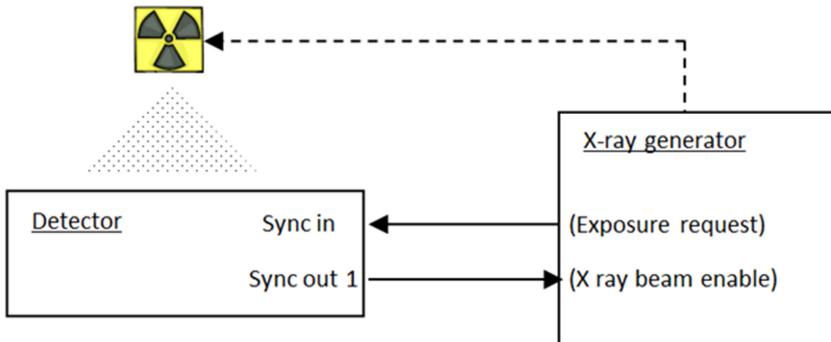


Figure 12: Sync connection for edge trigger mode.

In this case, the **Sync In** pulse is driven high when the user activates the 'Expose' button for the X-ray equipment. With the change of the **Sync Out 2** level the generator is informed that the detector is ready to receive the X-ray emission and starts to irradiate (Figure 13).

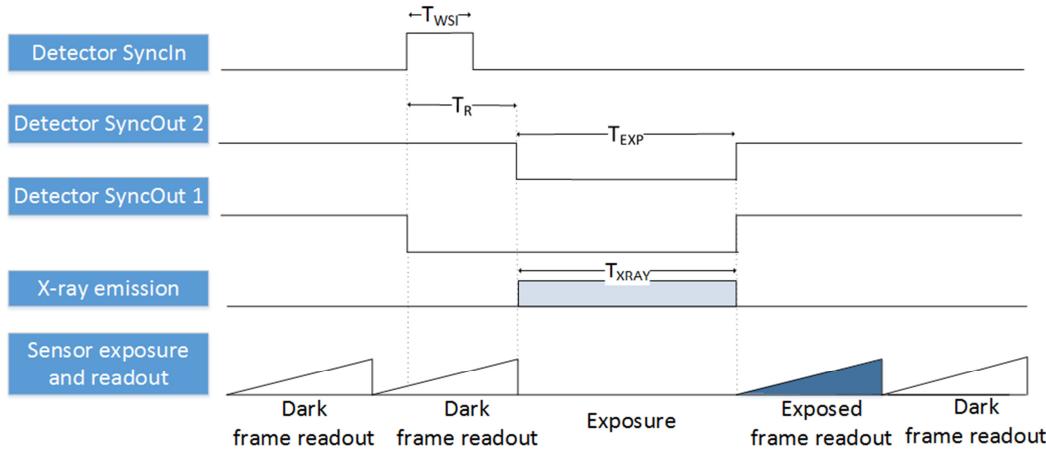


Figure 13: Edge trigger mode timing.

11.1.3 External duration trigger mode

In Duration Trigger Mode, the detector is triggered by an external signal, i.e. Generator. The detector exposure time is defined by the width of the pulse. In SCap, this mode is selected using **Configuration – External Trigger Mode – External Duration Trigger** and the following step:

1. Before exposure, the detector is continuously reading dark frames from the sensor.
2. The external trigger signal drives **Sync In** high when ready to begin image acquisition.
3. The current dark frame-read out finishes (T_R) and then the exposure period begins.
4. The detector continues exposing until the external trigger signal drives Sync In low.
5. The detector reads out the image and transmits it to the PC.
6. While Sync In is low, Sync Out continues to pulse at interval T_I .

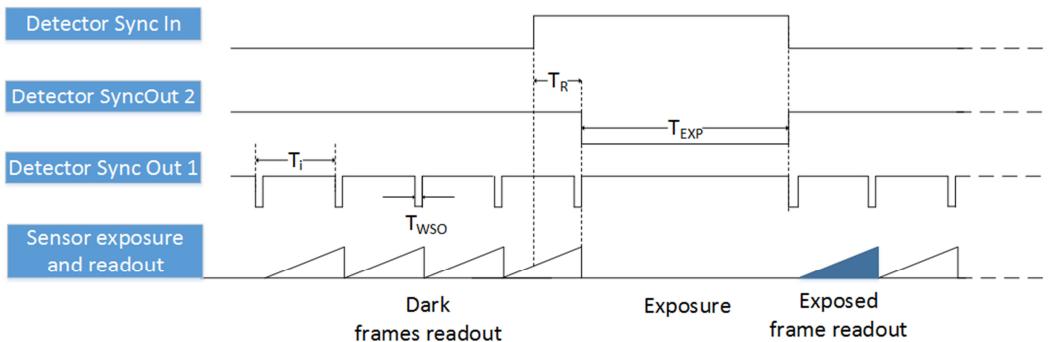


Figure 14: Duration trigger mode timing.

Symbol	Description	Value	Notes
T_I	Sync Out 1 idle pulse interval	1 frame readout time	
T_{WSO}	Sync Out 1 pulse width	2ms	
T_D	X-ray emission delay after Sync Out 1		Depends on the start-up characteristics of generator and tube
T_{RD}	frame start delay after Sync Out 1	Minimum = 3ms Maximum : See Frame readout times Table 4 to check the maximum reset time for each detector.	Programmed setting in detector. Ensure that $T_{RD} < T_D$
T_{FD}	Frame readout delay after Sync Out 1 inactive	Minimum = 0ms Maximum = 1.6s	Programmed setting in detector. Ensures that frame readout starts after the end of X-ray emission.

Table 9: Duration trigger mode specification.

Example - Trigger signal driven by the generator:

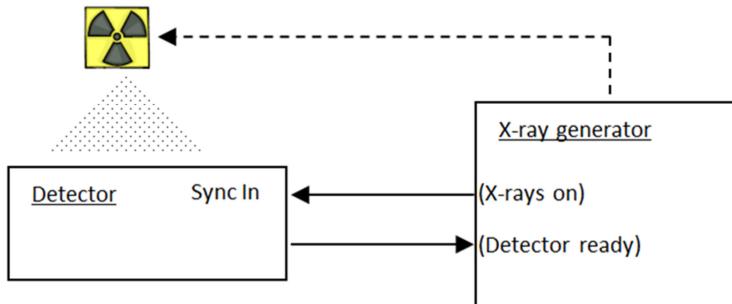


Figure 15: Sync connection for duration trigger mode.

The sequence is as follows:

1. Before exposure, the detector is continuously reading dark frames from the sensor.
2. The user activates the 'Expose' button for the X-ray equipment.
3. When the generator is ready to produce X-rays, it waits for the next **Sync Out** pulse from the detector.

4. At the active (falling) edge of **Sync Out**, the generator drives **Sync In** high, while starting the X-ray emission.
5. Immediately after the X-ray emission, the generator drives **Sync In** low. The detector reads out the image and transmits it to the PC.
6. While **Sync In** is low, **Sync Out** continues to pulse at interval T_1 .

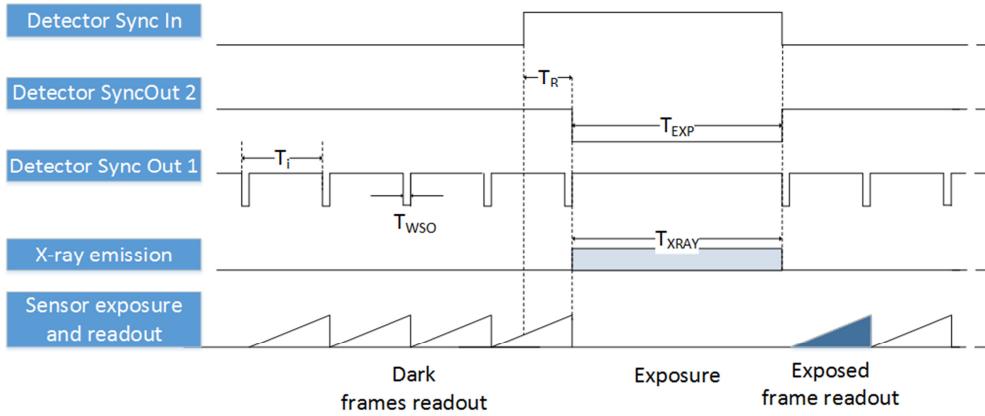


Figure 16: Duration trigger mode timing.

11.1.4 Signal levels

The signal levels on the trigger connectors are as follows. The core is the *positive* terminal, and the shell is the *negative* terminal.

Condition	Min	Max	Notes
Sync In = high	3 V	15 V	Input is opto-isolated from detector ground
Sync In = low	0 V	1.5 V	
Sync Out 1 & 2 = high	3.0	3.3 V	output impedance = 1.2kΩ
Sync Out 1 & 2 = low	0V	0.4 V	

Table 10: Signal levels.

11.2 Exposure modes

11.2.1 Expose and read

In Expose and Read Mode, the detector receives a trigger and grabs an image. This mode is compatible with the three trigger modes. In SCap, this mode is selected using **Configuration – Exposure Mode – Normal**.

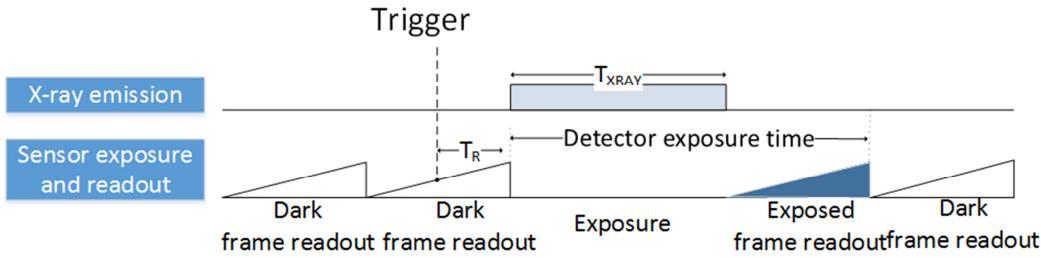


Figure 17: Expose and read mode.

11.2.2 Sequence exposure

In Sequence Exposure Mode, the detector receives a trigger and grabs certain number of images. The numbers of images and the detector exposure time (Exposure + Exposed frame readout in the image) have to be previously set by software (SCap or API). In SCap, this mode is selected using **Configuration – Exposure Mode – Sequence Exposure**.

Example: set of 3 images.

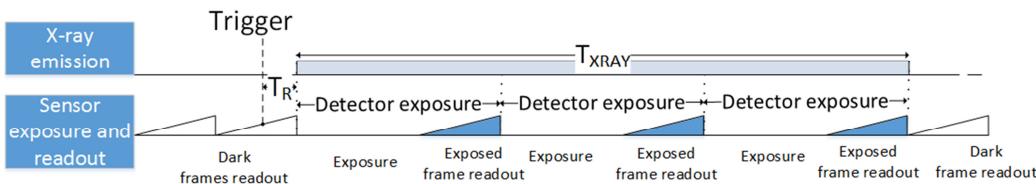


Figure 18: Sequence exposure mode.

11.2.3 Frame-rate exposure

In Frame-rate Exposure Mode, the detector receives a trigger and grabs certain number of images leaving a gap between exposures. The numbers of images, the detector exposure time and the gap between exposures have to be previously set by software (SCap or API). This mode only works with Software Trigger Mode and External Edge Trigger Mode. In SCap, this mode is selected using **Configuration – Exposure Mode – Frame rate mode**.

Example: set of 2 images.

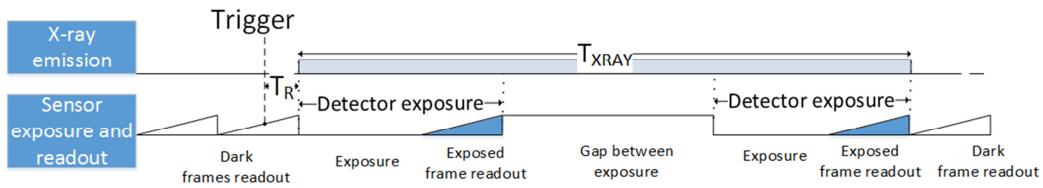


Figure 19: Frame rate mode timing.

11.2.4 Pre-programmed exposure

In Pre-programmed Exposure Mode, the detector receives a trigger and grabs certain number of images that can have different detector exposure times. The number of images (with a maximum of 4) and the detector exposure time of each image have to be previously set by software (SCap or API). This mode only works with Software Trigger Mode and External Edge Trigger Mode. In SCap, this mode is selected using **Configuration – Exposure Mode – Pre-programmed Exposure**.

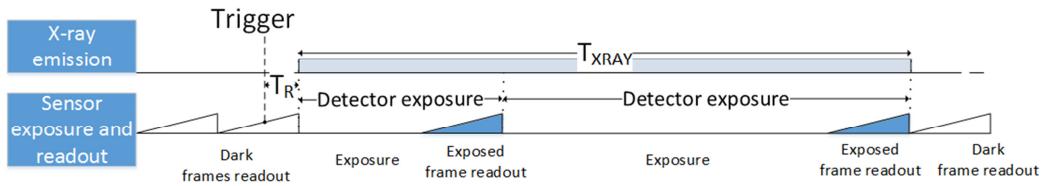


Figure 20: Pre-programmed exposure mode, 2 images example.

11.2.5 Pre-shot mode

This mode is like the Pre-programmed one, but just 2 images can be programmed. This is used mostly for High Dynamic Range imaging.

12 Installation in a medical system: data connection to the PC

X-ray systems which comply with international safety standards for medical devices (IEC 60601-1) are designed with high levels of protection against mains failure. This includes protection against low leakage current from the enclosure under normal and single-fault (e.g. mains earth disconnection) conditions.

Some types of PC, for example medical panel PCs which have an insulating touch keypad, are rated to medical standards (IEC 60601-1), and a direct connection can be made without modification of the mains supply or data connection. However, when the detector is connected directly to a PC which is not designed to medical equipment standards, the data connection (e.g. Camera Link) could cause excessive leakage current to flow into the detector. This would compromise the electrical safety of the medical system, to a point where it no longer complies with medical equipment safety standards.

Some guidelines are as follows:

1. In a medical system incorporating the detector as a component:
 - a. The leakage current from the detector enclosure to other parts of the medical system should be less than 0.1mA rms, when power is applied.
 - b. When the PC mains earth terminal is disconnected, and the PC and detector are powered on, the leakage current from the detector enclosure to other parts of the medical system should be less than 0.5mA rms.

A combination of protection techniques can be used to reduce the leakage current to below these levels:

- Additional protective earthing of the detector to the medical system (for both CL and GigE, Figure 21 below)
 - Common protective earth between the detector and the PC, in addition to protective earthing to the medical system (for both CL and GigE, Figure 22 below)
 - Electrical isolation of the Camera Link signals (Figure 23 below)
 - Isolation of the PC from its electrical environment (for both CL and GigE, Figure 24 below)
2. Where the PC is located outside the X-ray room, an additional protective earth cable must connect the PC and the detector, if they do not share a common mains earth. Alternatively, an isolator should be used in the Camera Link connection. A Camera Link to fibre converter would provide isolation.
 3. Where the PC is located within the patient environment, within 1.5m of the patient, a common earth wire should be used to provide additional protection. Alternatively, or in addition, mains isolation can be used.

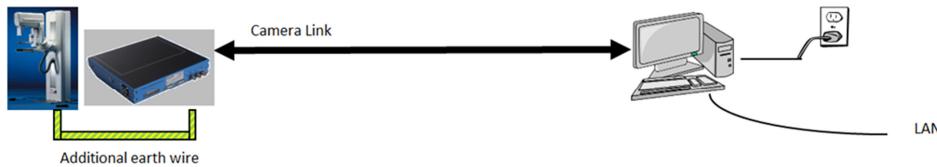


Figure 21: Detector earthed to medical equipment. The same applied to GigE.

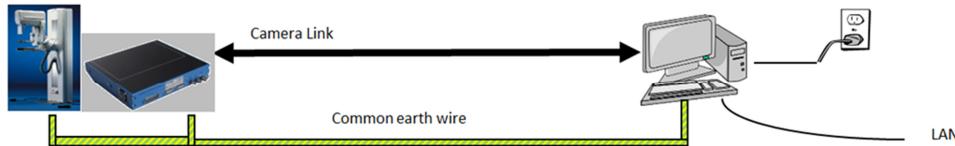


Figure 22: Protective earth between detector and PC. The same applied to GigE.

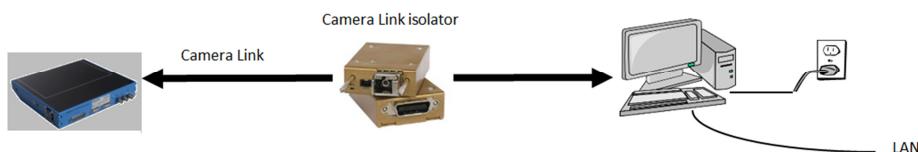


Figure 23: Camera Link isolation

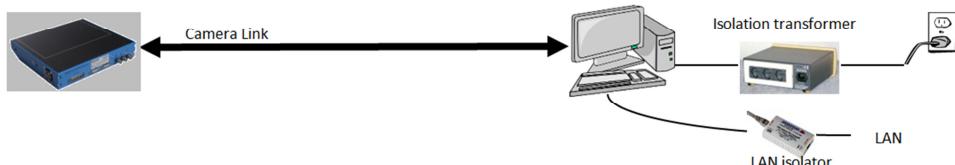


Figure 24: Mains and LAN isolation. The same applied to GigE.

13 Disposal – Waste Electrical and Electronic Equipment (WEEE)

If the detector is activated by high energy x-rays, gamma rays, or neutrons follow the local radiation protection regulation.

Contact your supplier or distributor, and check the terms of conditions of the purchase contract. This product should not be mixed with other commercial waste for disposal.



A label with a crossed-out wheeled bin symbol and a rectangular bar indicates that the product is covered by the Waste Electrical and Electronic Equipment (WEEE) Directive and is not to be disposed of as unsorted municipal waste. Any products marked with this symbol must be collected separately, according to the regulatory guidelines in your area.

The objectives of this program are to preserve, protect, and improve the quality of the environment, protect human health, and utilize natural resources prudently and rationally. Specific treatment of WEEE is indispensable in order to avoid the dispersion of pollutants into the recycled material or waste stream. Such treatment is the most effective means of protecting the customer's environment.

Requirements for waste collection, reuse, recycling, and recovery programs vary by regulatory authority at your location. Contact your local responsible body (for example, your hospital, clinic, establishment, or site manager) or authorized representative for information regarding applicable disposal regulations. Contact PerkinElmer at the Web site listed below for information specific to PerkinElmer products.

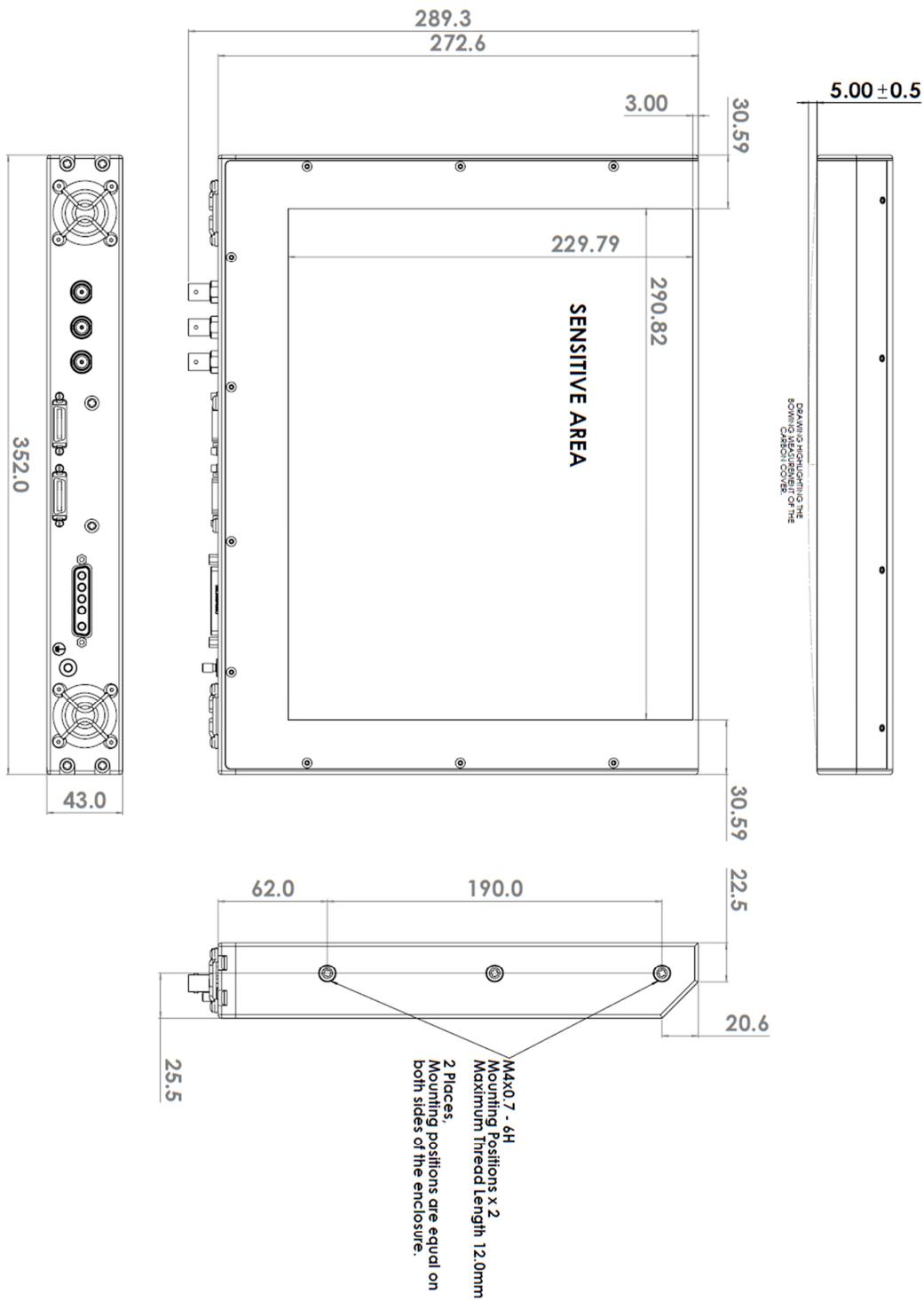
Web Address:

<http://www.perkinelmer.com/pages/010/onesource/environmental-health-and-safety/environmental-directives-compliance.xhtml>

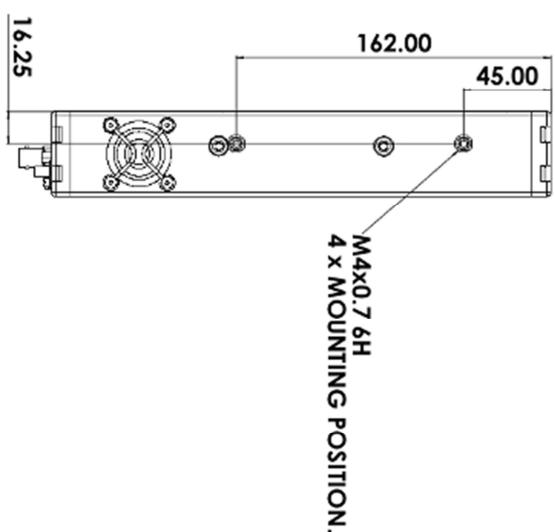
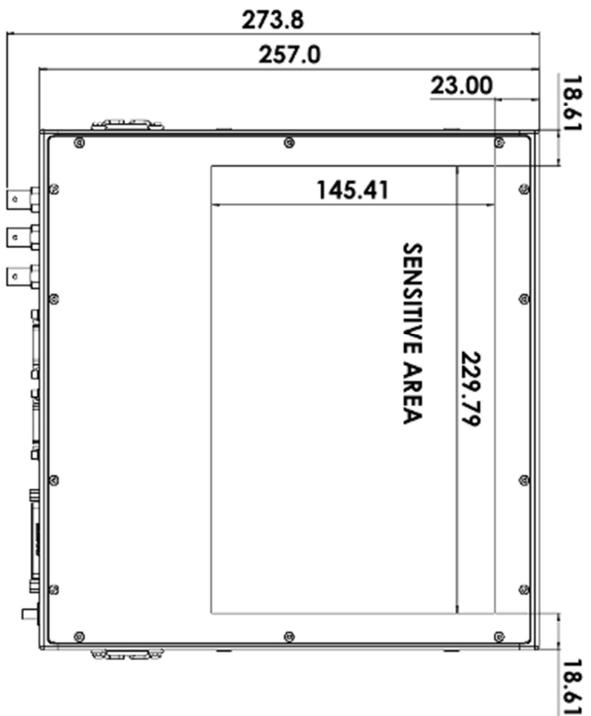
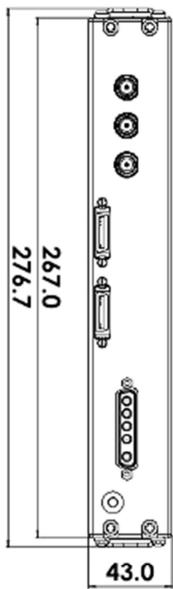
The PerkinElmer product may be attached as part of a component to other manufacturers' systems. These other manufacturers are directly responsible for the collection and processing of their own waste products under the terms of the WEEE Directive. Contact these producers directly before discarding any of their products. Consult the PerkinElmer Web site (above) for producer names and Web addresses.

14 Appendix 1 – Technical drawings

2923MAM CL

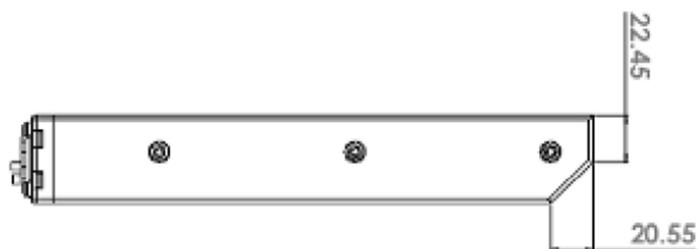
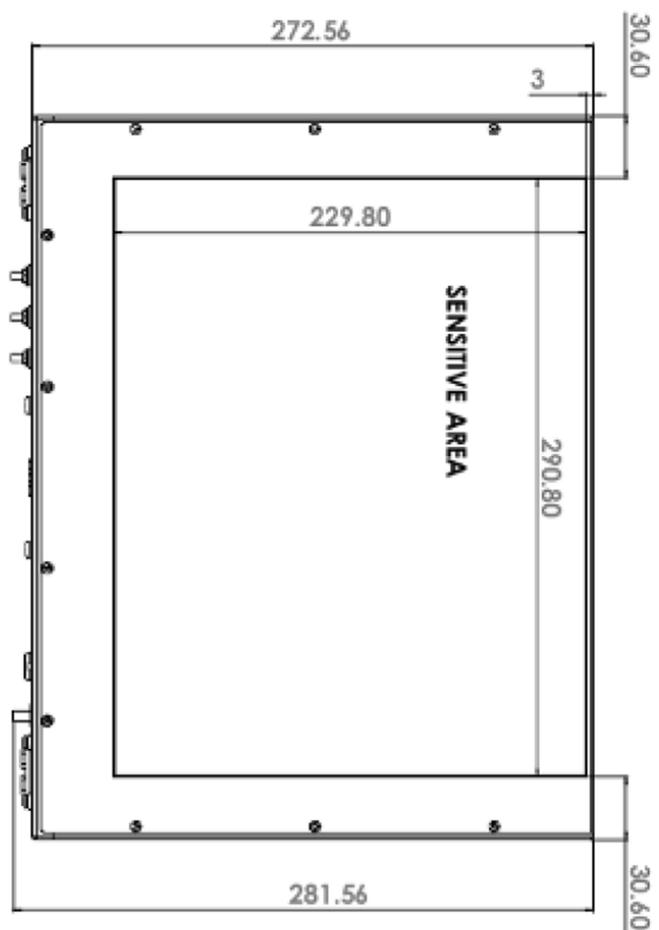


2315MAM CL



2923MAM GigE

352



15 Appendix 2 - Installing and configuring Epix Camera Link cards



15.1 Overview

Dexela optionally supplies the Epix E4 (dual cable) or EB1 (single cable) Camera Link card with its detectors.

This Annex describes how to

- install the card and its supporting software
- configure memory for storing multiple images
- create a Camera Link configuration file (.FMT) for third-party applications if using the Dexela or Epix libraries.

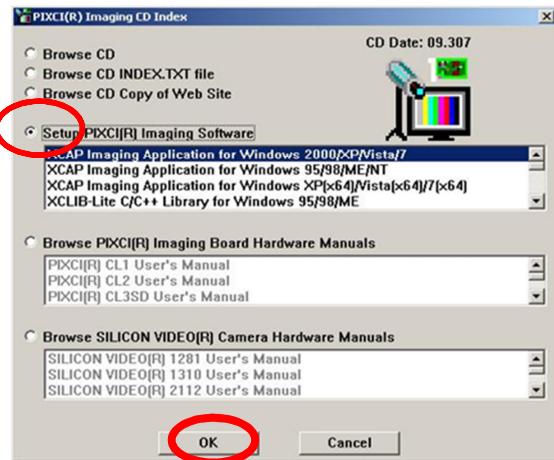
15.2 Installing the card

Plug the card into a spare PCIe x4 or PCIEx16 slot. A PCIe x16 slot is preferred. On many PCs, at least one PCIe x16 slot is wired directly into DMA memory, which provides maximum speed.

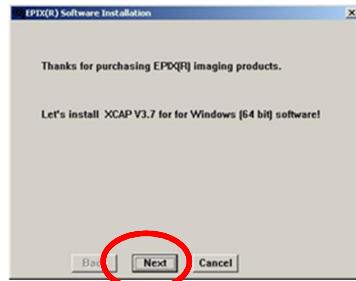
15.3 Installing the Software and Driver

Insert the Epix CD provided with the board. The **PIXCI(R) Imaging CD Index** dialog box should be displayed; if not, browse to the CD drive and run **setup.exe**.

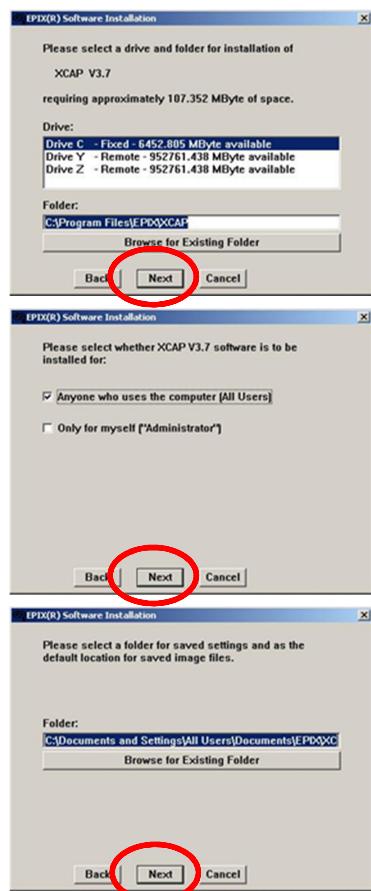
Select **Setup PIXCI(R) Imaging Software** and then click on **XCAP Imaging Application** with the appropriate OS platform. Then click **OK**.

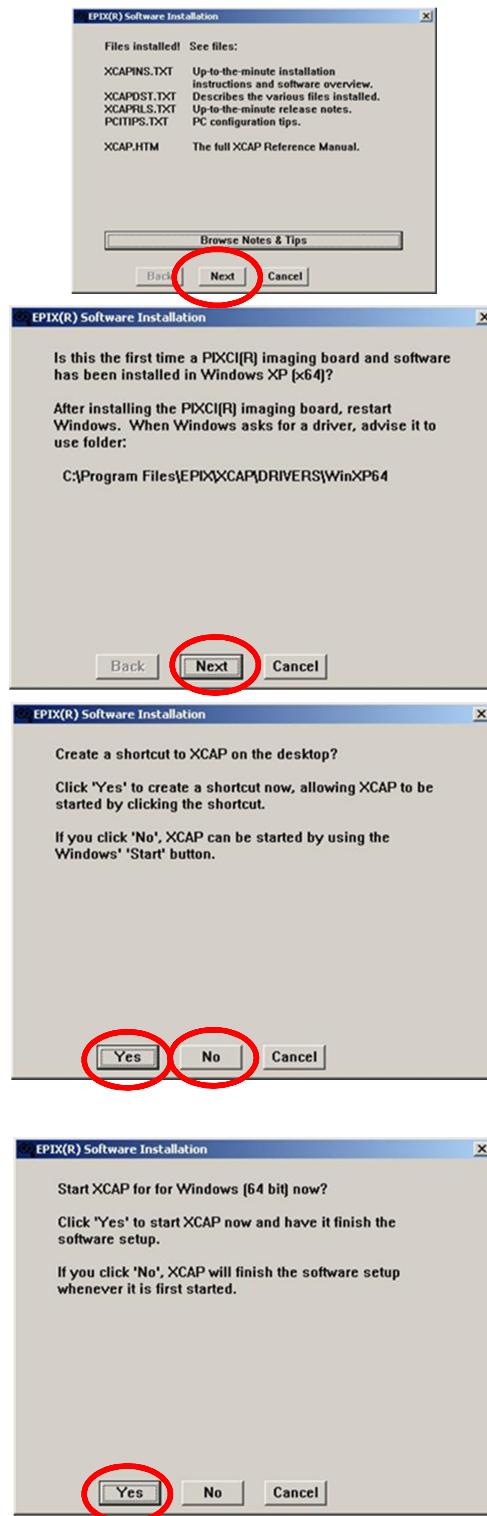


On the following screen, click **Next**



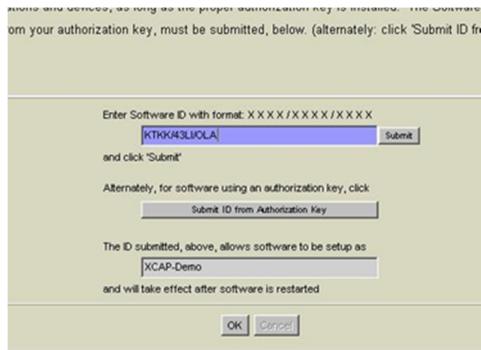
On the following series of dialog boxes, select the default options, unless other options (e.g. another disk drive) are required





The Camera Link driver can now be installed. In the next dialog box, note that the path for a 32-bit Windows installation be different to the 64-bit folder shown:

Select **Yes** to start XCAP. Click **Agree** after reading the licence terms, enter the Software ID on the dialog box which follows. The Software ID is printed on the envelope which contains the driver CD. Keep this in a safe place, as the code will be needed if the drivers need to be re-installed.



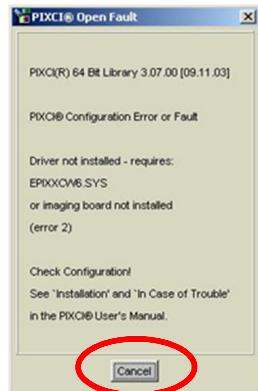
Now restart the computer. It will recognise the new card and start the New Hardware Wizard.

When Windows has found the driver, the following dialog box is displayed. Click **Continue Anyway**.



15.4 If the driver is not detected by Windows

If the New Hardware Wizard does not appear, the driver can be installed using the XCAP software. Launch XCAP, and the following dialog will appear. Click **Cancel**.



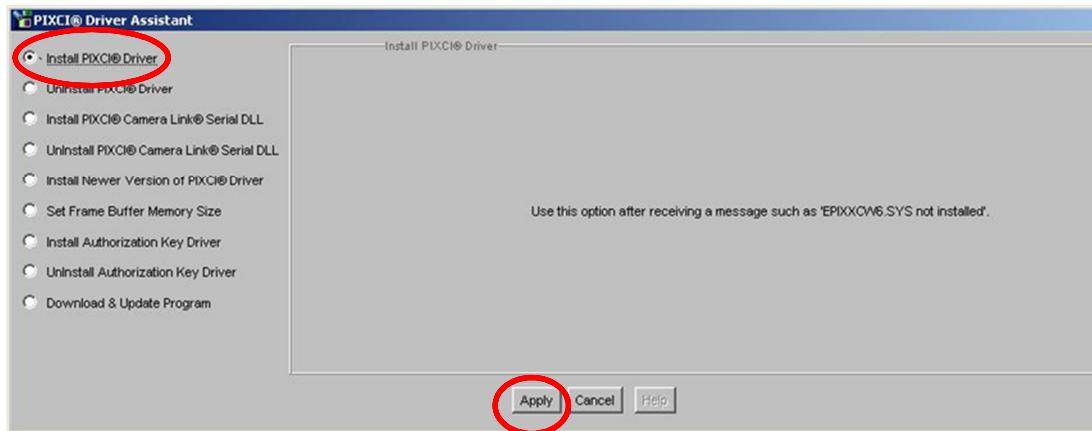
Then choose the menu item **PIXCI® Open /Close** from the **PIXCI** menu:



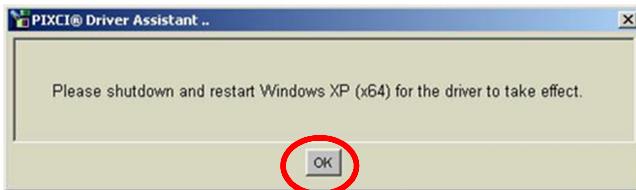
Select **Driver Assistant** from the dialog box.



On the next dialog box, select **Install PIXCI Driver** and then click **Apply**. The driver will then be installed.



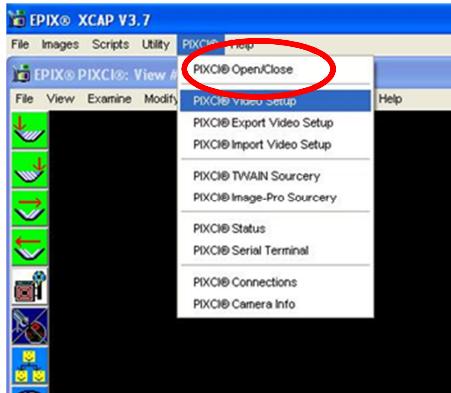
After installation is finished, click **OK** to reboot the PC:



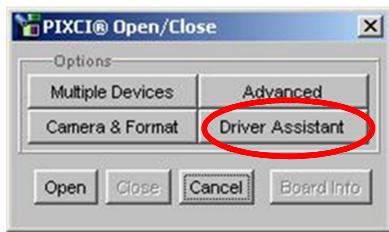
15.5 Configuring memory for the frame buffer

To store multiple frames from the card, sufficient system memory must be allocated. The minimum should be about 5 frames, but more may be needed according to the application. The frame partition size should be at least as big as one frame. In this example the partition size is set to 24MBytes as the frame size (for the 2923 detector at full resolution) is 22.8MBytes.

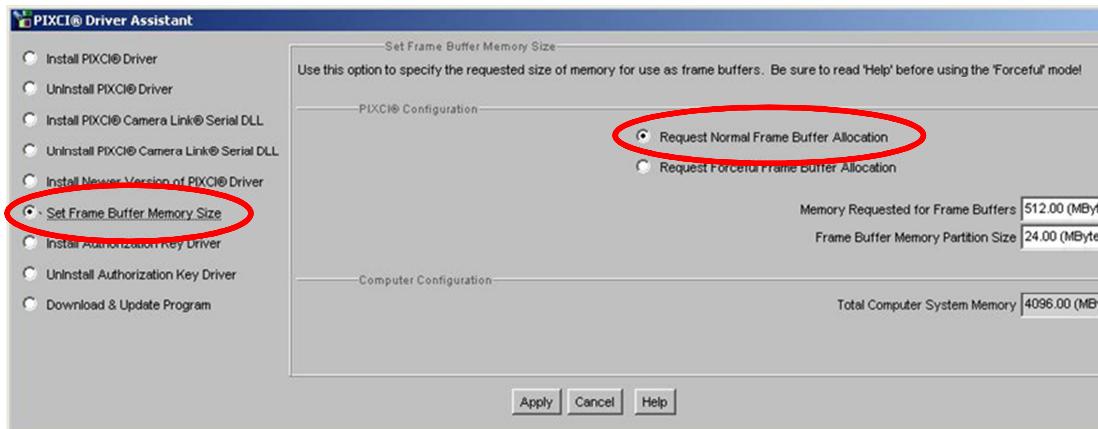
First select **PIXCI® Open / Close** from the **PIXCI** menu:



Select **Driver Assistant**:



Then select **Set Frame Buffer Memory Size**.



Request Normal Frame Buffer Allocation should normally be chosen, but refer to the Epix documentation for other options. In the example shown, the **Use Default** checkbox has been cleared, the reserved memory (**Memory Requested for Frame Buffers**) has been set to 512MBytes and the **Frame Buffer Memory Partition Size** to 24MB.

Note the **Total Computer System Memory** figure which is displayed. This will give an indication of how much frame buffer memory can be used. The frame buffer memory should be at least 1GByte less than the total system memory.

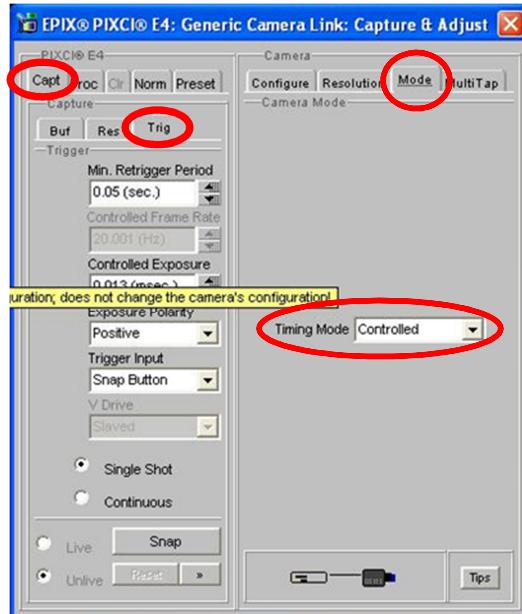
15.6 Creating FMT files for use of third party applications

SCap, the Dexela SDK and other third-party software that uses the XCLIBWNT.dll (XClib library) all require a camera setup or format file called an FMT file. This file can be created using the XCAP software. This section describes how to configure XCAP for different types of camera, and to export the FMT file for use by other programs.

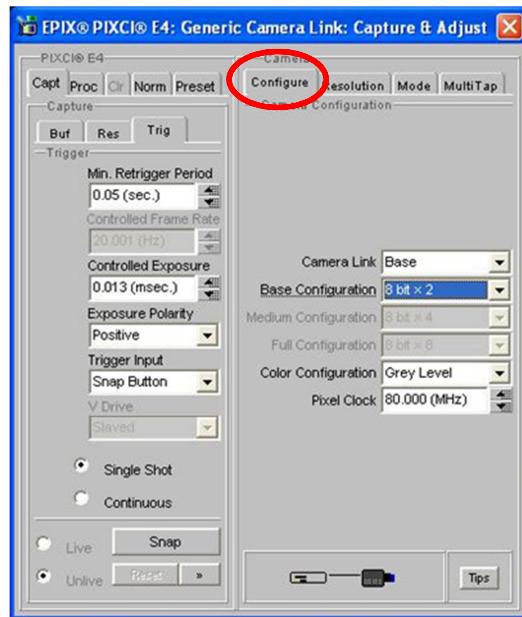
When XCAP opens, it will display a dialog box with the title **Generic Camera Link: Capture & Adjust**. This controls most of the camera configuration.

First click on the **Mode** tab. The **Timing Mode** should be set to **Controlled**.

Then select the **Capt** tab, and the **Trig** tab below. Set the **Min Retrigger Period**, the **Controlled Exposure** pulse time, the **Exposure Polarity** and the **Trigger Input** to the desired values as shown in the example below:



Next select the **Configure** Tab. Under this tab, the type of Camera Link interface is defined. The choices are **Base**, **Medium** or **Full**. Select **Grey Level** for **Color Configuration**, and **80MHz** for **Pixel Clock**. For Base configuration (e.g. 1512) select **8 bit x 2**. For Medium configuration (e.g. 2315) select **8 bit x 4**. For Full configuration (e.g. 2923) select **8 bit x 8**.



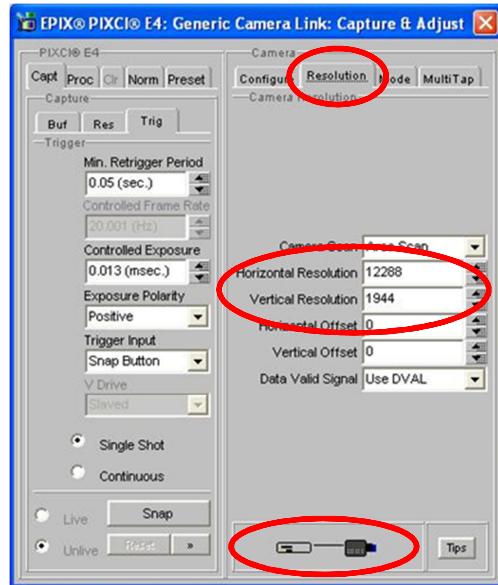
Next, the dimensions and scope of the data are defined.

Pixels are specified in units of bytes. Where sensors are tiled (e.g. 2315, 2923) the bit maps are combined horizontally into a contiguous region. As an example (see dialog boxes below) the four sensors in the 2923 are mapped side-by-side instead of in a 2×2 pattern, giving 6144 pixels (=12288 bytes) \times 1944 lines. The pixels from tiled sensors are read off as interlaced, and the picture displayed by XCAP is therefore scrambled.

2923 2315

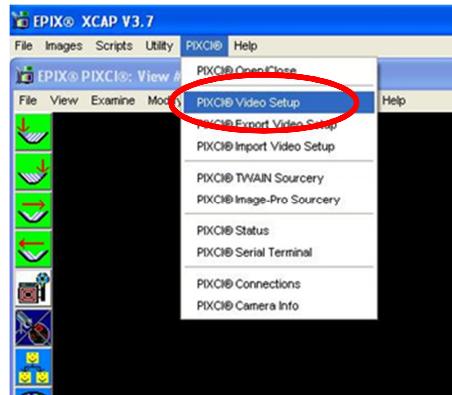
Horizontal resolution	12288	6144
Vertical resolution	1944	1944

At the foot of the dialog box, a camera icon is joined to a card icon. If there is Camera Link communication with the camera, the icon will display activity. If no activity is shown when the **Snap** button is clicked, refer to ‘Communicating with the Detector’ in the Troubleshooting section.

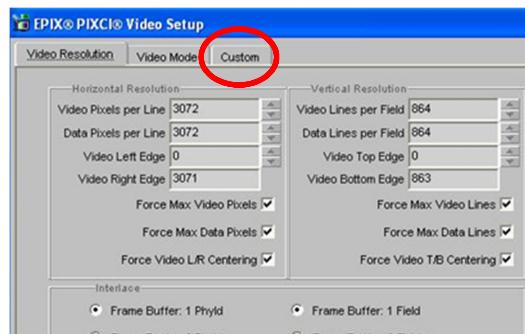


The software trigger mechanism which drives the Camera Link CC1 signal must be configured to provide third-party access. This will affect XCAP’s ability to function using the Snap button, so it should be reset once the FMT file has been exported.

First choose **PIXCI Video Setup** from the **PIXCI** menu.

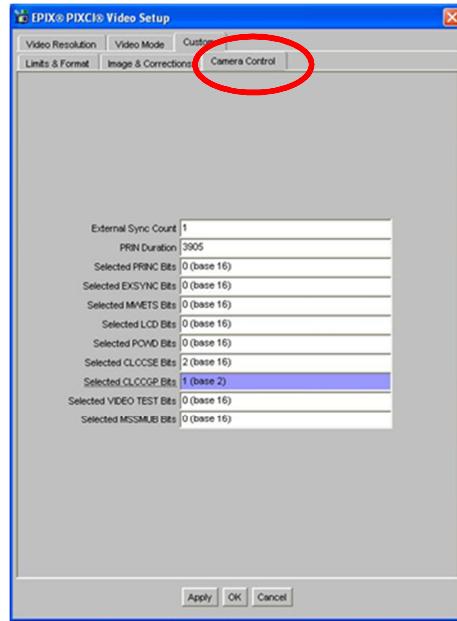


In the next dialog box select the **Custom** Tab.

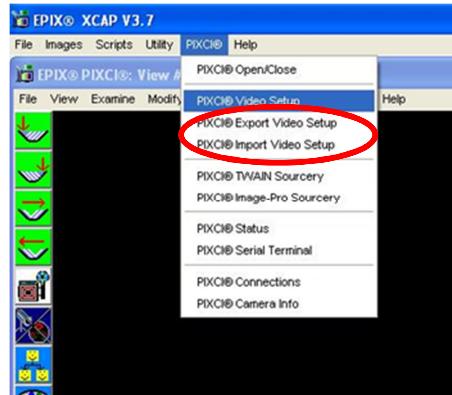


Select the **Camera Control** tab. Set **Selected CLCCGP Bits** to 1 (the default is 0).

Click on **Apply** and then **OK**.



The Video setup can now be exported. Choose **Export Video Setup** from the **PIXCI** menu. In the dialog choose a path and file name, then click **Apply** and **OK**. The FMT file is now ready for use by other programs.



15.7 Troubleshooting

PCI overflows are caused by the PC architecture not being able to handle the data throughput. Try using a PCIe x16 slot that is recommended for the main graphics card as this may have better throughput compared with the other slots. Epix Inc (see www.epixinc.com) may be able to help in finding approved motherboards.

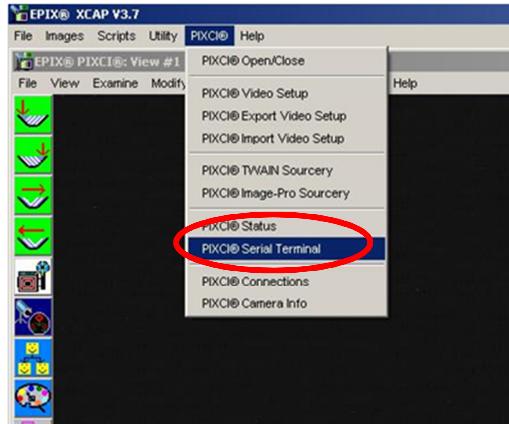
Communicating with the detector.

If the detector does not respond to Camera Link communication, first check that:

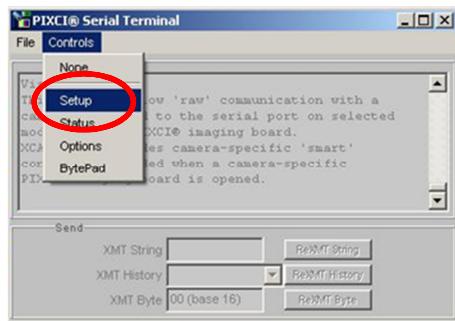
- the power supply is on
- the power cable is connected
- The Camera Link cables are connected the right way round. Connector 1 should be connected to the lower (nearest the motherboard) port of the Epix frame grabber.

If the detector appears to be powered on and connected correctly, it may required an initialization command to be sent to start the Camera link Interface.

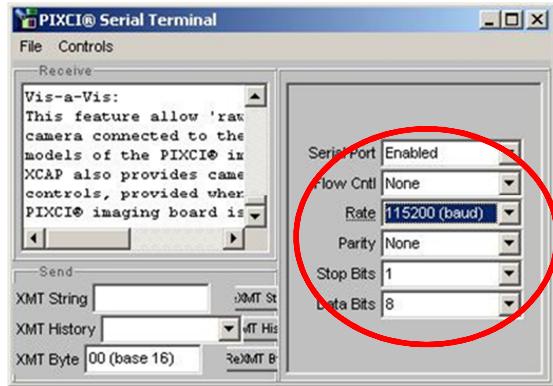
First choose **PIXCI Serial Terminal** from the **PIXCI** menu.



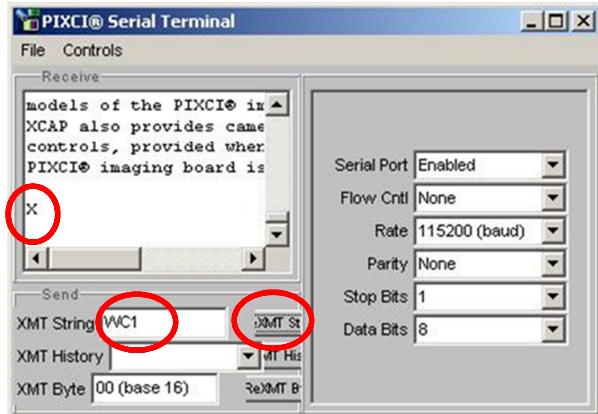
Then in the resulting dialog box choose **Setup** from the **Controls** drop down menu.



Configure the terminal settings as shown. The only change from the default is to set **Rate** to 115200.



Now issue the Camera Link wake-up command to the detector by typing **WC1** in the **XMT String** text box and clicking the button to the right. In the Receive window, you should see the detector return **X** as confirmation of a successful command.



The detector is now ready to accept capture requests. Having established communication, it is recommended to close XCAP and use SCap instead for further

work, since this will set up camera offsets and descramble the interleaved pixels to display a coherent image.

15.8 Installing and configuring of GigE devices

The instruction to install drivers and software for GigE devices can be found in the document DX-001308 (revision A), that can be found in the SDK cd sent together with a GigE detector.